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PATENT & TRADEMARK OFFICE

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\$ Receipt
Attorney's Docket No. 5353C2/459005
D.A.C.
(S)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Wallace T.Y. Tang Art Unit : Unknown
Serial No. : 09 909,766 Examiner : Unknown
Filed : July 19, 2001
Title : IN-SITU REAL-TIME MONITORING TECHNIQUE AND APPARATUS FOR
ENDPOINT DETECTION OF THIN FILMS DURING CHEMICAL/MECHANICAL
POLISHING PLANARIZATION

Commissioner for Patents
Washington, D.C. 20231

CORRECTION OF SMALL ENTITY STATUS
AND REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

This application did not and does not request small entity status. The calculation of fees as a large entity on page 2 of the transmittal later was correct. The designation of this application as claiming small entity status was Patent Office error.

It appears that a \$579.00 credit was received from the Patent Office. Enclosed is a check for \$579.00 for payment of the deficiency.

Please correct the Filing Receipt for the above-referenced application to designate "Large Entity".

Please supply a corrected Filing Receipt to the undersigned with respect to this application. A copy of the original Filing Receipt showing the desired changes in red ink is attached for your convenience.

If there are any other charges or credits, please apply them to Deposit Account No. 06-1050.

Adjustment date: 03/21/2002 AWONDAF1
06/17/2001 YGIZAW 00000001 09909766
01 FC:101 - 355.00 OP
02 FC:202 - 80.00 OP
03 FC:203 - 144.00 OP

03/21/2002 AWONDAF1 00000146 061050 09909766

01 FC:101 161.00 CH 579.00 OP
02 FC:103 288.00 CH
03 FC:102 168.00 CH

The PTO did not receive the following
listed item(s) A check of \$ 579.00

DO NOT FILE
ORIGINALLY FILE

CERTIFICATE OF MAILING BY FIRST CLASS MAIL

I hereby certify under 37 CFR §1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

February 20, 2002
Date of Deposit

Signature

Carlos Brasil

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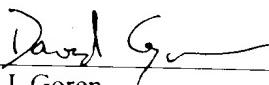
Applicant : Wallace T.Y. Tang
Serial No. : 09 909,766
Filed : July 19, 2001
Page : 2

Attorney's Docket No.: 05542-459005 5353C2/CMP

Respectfully submitted,

Date: 2/20/02

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UNITED STATES PATENT AND TRADEMARK OFFICE

Page 1 of 3
BH
Please Correct Small Entity
IDS 10-19-01

NO CIVL.

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY.DOCKET.NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/909,766	07/19/2001	1763	579	5353C2/459005	4	36	5

CONFIRMATION NO. 2971

FILING RECEIPT



"OC000000006440845"

RECD AUG 21 2001

Date Mailed: 08/17/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Wallace T. Y. Tang, Warren, NJ;

Assignment For Published Patent Application

Applied materials, Inc., a Delaware corporation;

Domestic Priority data as claimed by applicant

THIS APPLICATION IS A CON OF 07/996,817 12/28/1992

Foreign ApplicationsCOPY OF PAPERS
ORIGINALLY FILED**If Required, Foreign Filing License Granted 08/10/2001****Projected Publication Date:** 11/29/2001**Non-Publication Request:** No**Early Publication Request:** No

SMALL ENTITY
LARGE ENTITY

Title

COMPUTER ENTERED
AUG 21 2001

In-situ real-time monitoring technique and apparatus for endpoint detection of thin films during

8408 563 6821

AMAT IP

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Page 2 of 3

chemical/mechanical polishing planarization

Preliminary Class

438

Data entry by : SEDIQEE, AHMADULLAH

Team : OIPE

Date: 08/17/2001

